

P-Channel 30 V (D-S) MOSFET

PowerPAK® 1212-8SH

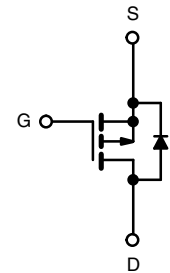

FEATURES

- TrenchFET® power MOSFET
- Low thermal resistance PowerPAK® package with small size
- 100 % R_g and UIS tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912


RoHS
 COMPLIANT
 HALOGEN
FREE

APPLICATIONS

- Load switch
- Adapter switch
- Notebook PC



P-Channel MOSFET

PRODUCT SUMMARY

V _{DS} (V)	-30
R _{DS(on)} max. (Ω) at V _{GS} = -10 V	0.0114
R _{DS(on)} max. (Ω) at V _{GS} = -4.5 V	0.0200
Q _g typ. (nC)	24.6
I _D (A) ^{e, f}	-35
Configuration	Single

ORDERING INFORMATION

Package	PowerPAK 1212-8
Lead (Pb)-free and halogen-free	SiSH129DN-T1-GE3

ABSOLUTE MAXIMUM RATINGS (T_A = 25 °C, unless otherwise noted)

PARAMETER	SYMBOL	LIMIT	UNIT
Drain-source voltage	V _{DS}	-30	V
Gate-source voltage	V _{GS}	± 20	
Continuous drain current (T _J = 150 °C)	I _D	T _C = 25 °C	-35 ^e
		T _C = 70 °C	-35 ^e
		T _A = 25 °C	-14.4 ^{a, b}
		T _A = 70 °C	-11.5 ^{a, b}
Pulsed drain current	I _{DM}	-60	A
Continuous source-drain diode current	I _S	T _C = 25 °C	
		T _A = 25 °C	-3.2 ^{a, b}
Avalanche current	I _{AS}	-25	mJ
Single pulse avalanche energy	E _{AS}	31.25	
Maximum power dissipation	P _D	T _C = 25 °C	52.1
		T _C = 70 °C	3.3
		T _A = 25 °C	3.8 ^{a, b}
		T _A = 70 °C	2.4 ^{a, b}
Operating junction and storage temperature range	T _J , T _{stg}	-50 to +150	°C
Soldering recommendations (peak temperature) ^{c, d}		260	

Notes

- Surface mounted on 1" x 1" FR4 board
- t = 10 s
- See solder profile (www.vishay.com/doc?73257). The PowerPAK 1212-8SH is a leadless package within the PowerPAK 1212-8 package family. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection
- Rework conditions: manual soldering with a soldering iron is not recommended for leadless components
- Package limited
- Based on T_C = 25 °C



THERMAL RESISTANCE RATINGS						
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT	
Maximum junction-to-ambient ^{a, b}	$t \leq 10$ s	R_{thJA}	26	33	°C/W	
Maximum junction-to-case (drain)	Steady state	R_{thJC}	1.9	2.4		

Notes

- a. Surface mounted on 1" x 1" FR4 board
- b. Maximum under steady state conditions is 81 °C/W

SPECIFICATIONS ($T_J = 25$ °C, unless otherwise noted)						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static						
Drain-source breakdown voltage	V_{DS}	$V_{GS} = 0$ V, $I_D = -250$ μ A	-30	-	-	V
V_{DS} temperature coefficient	$\Delta V_{DS}/T_J$	$I_D = -250$ μ A	-	-20	-	mV/°C
$V_{GS(th)}$ temperature coefficient	$\Delta V_{GS(th)}/T_J$		-	5	-	
Gate-source threshold voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}$, $I_D = -250$ μ A	-1.5	-	-2.8	V
Gate-source leakage	I_{GSS}	$V_{DS} = 0$ V, $V_{GS} = \pm 20$ V	-	-	± 100	nA
Zero gate voltage drain current	I_{DSS}	$V_{DS} = -30$ V, $V_{GS} = 0$ V	-	-	-1	μ A
		$V_{DS} = -30$ V, $V_{GS} = 0$ V, $T_J = 55$ °C	-	-	-10	
On-state drain current ^a	$I_{D(on)}$	$V_{DS} \leq -5$ V, $V_{GS} = -10$ V	-20	-	-	A
Drain-source on-state resistance ^a	$R_{DS(on)}$	$V_{GS} = -10$ V, $I_D = -14.4$ A	-	0.0095	0.0114	Ω
		$V_{GS} = -4.5$ V, $I_D = -11.5$ A	-	0.0160	0.0200	
Forward transconductance ^a	g_{fs}	$V_{DS} = -15$ V, $I_D = -14.4$ A	-	37	-	S
Dynamic ^b						
Input capacitance	C_{iss}	$V_{DS} = -15$ V, $V_{GS} = 0$ V, $f = 1$ MHz	-	2230	3345	pF
Output capacitance	C_{oss}		-	385	578	
Reverse transfer capacitance	C_{rss}		-	322	-	
Total gate charge	Q_g	$V_{DS} = -15$ V, $V_{GS} = -10$ V, $I_D = -14.4$ A	-	47.5	71	nC
		$V_{DS} = -15$ V, $V_{GS} = -4.5$ V, $I_D = -14.4$ A	-	24.6	37	
Gate-source charge	Q_{gs}	$f = 1$ MHz	-	7.7	-	nA
Gate-drain charge	Q_{gd}		-	12	-	
Gate resistance	R_g		0.4	1.8	3.6	
Turn-on delay time	$t_{d(on)}$	$V_{DD} = -15$ V, $R_L = 1.5$ Ω $I_D \cong -10$ A, $V_{GEN} = -4.5$ V, $R_g = 1$ Ω	-	50	75	ns
Rise time	t_r		-	43	65	
Turn-off delay time	$t_{d(off)}$		-	30	45	
Fall time	t_f		-	14	21	
Turn-on delay time	$t_{d(on)}$	$V_{DD} = -15$ V, $R_L = 1.5$ Ω $I_D \cong -10$ A, $V_{GEN} = -10$ V, $R_g = 1$ Ω	-	14	21	ns
Rise time	t_r		-	9	18	
Turn-off delay time	$t_{d(off)}$		-	36	54	
Fall time	t_f		-	10	20	
Drain-Source Body Diode Characteristics						
Continuous source-drain diode current	I_S	$T_C = 25$ °C	-	-	-35 ^e	A
Pulse diode forward current ^a	I_{SM}		-	-	-60	
Body diode voltage	V_{SD}	$I_F = -10$ A	-	-0.8	-1.2	V
Body diode reverse recovery time	t_{rr}	$I_F = -10$ A, $di/dt = 100$ A/ μ s, $T_J = 25$ °C	-	31	47	ns
Body diode reverse recovery charge	Q_{rr}		-	30	45	nC
Reverse recovery fall time	t_a		-	15	-	ns
Reverse recovery rise time	t_b		-	16	-	

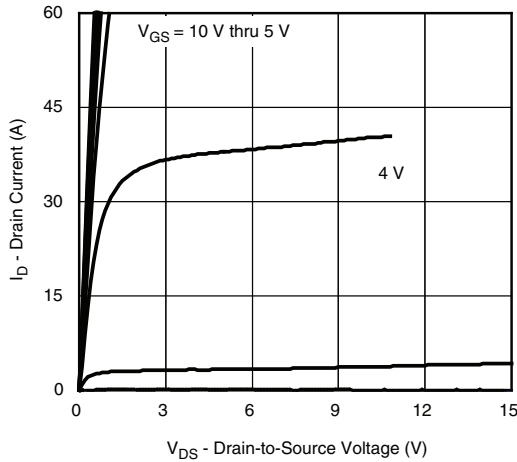
Notes

- a. Pulse test: pulse width ≤ 300 μ s, duty cycle ≤ 2 %
- b. Guaranteed by design, not subject to production testing

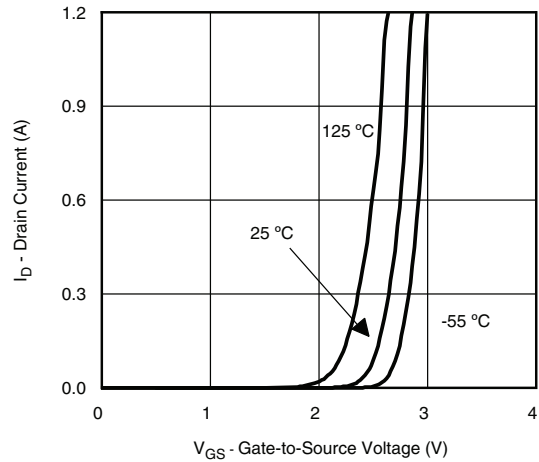
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



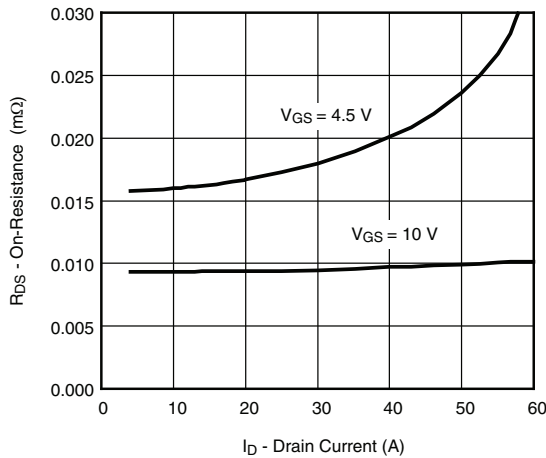
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



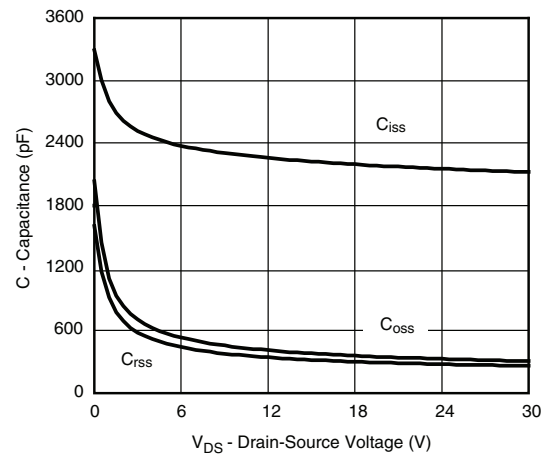
Output Characteristics



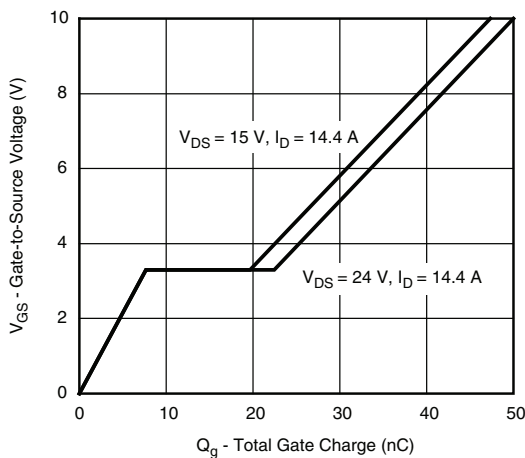
Transfer Characteristics



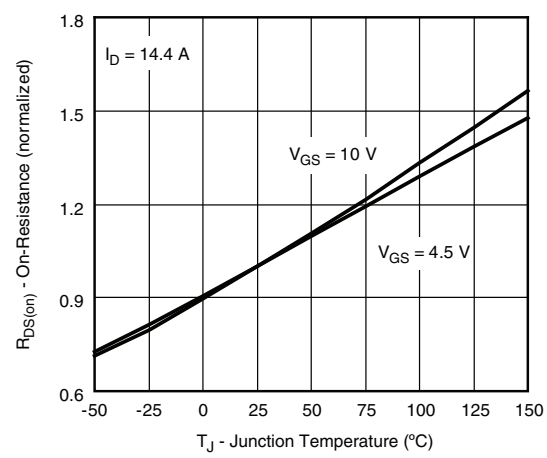
On-Resistance vs. Drain Current and Gate Voltage



Capacitance



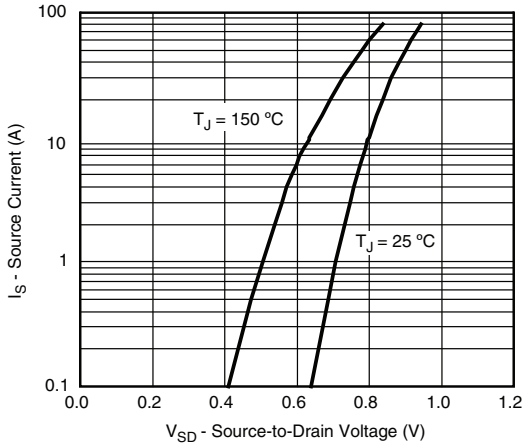
Gate Charge



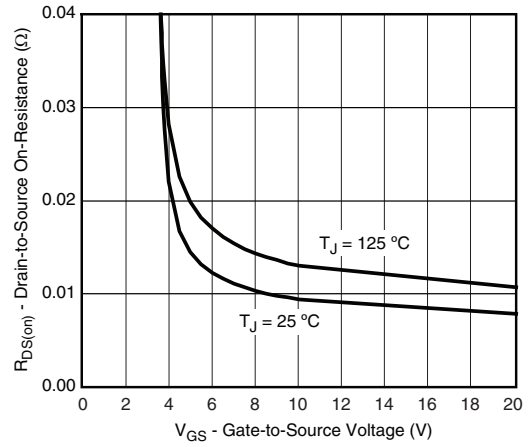
On-Resistance vs. Junction Temperature



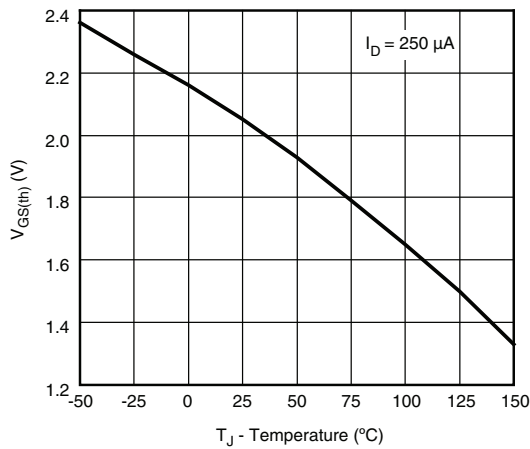
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



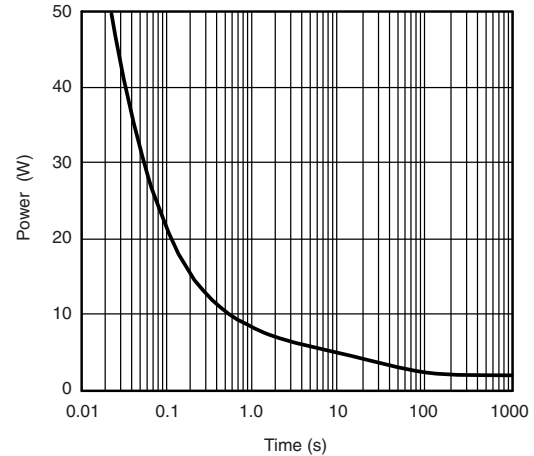
Source-Drain Diode Forward Voltage



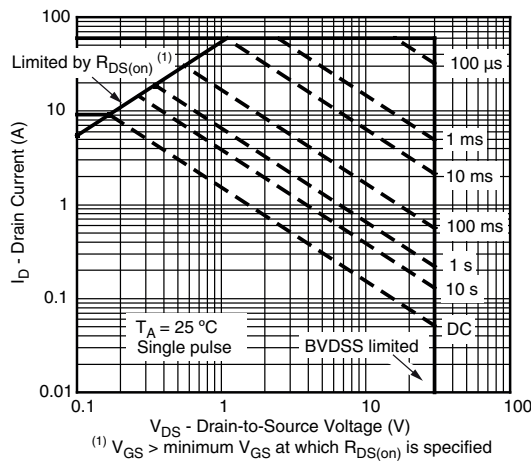
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage



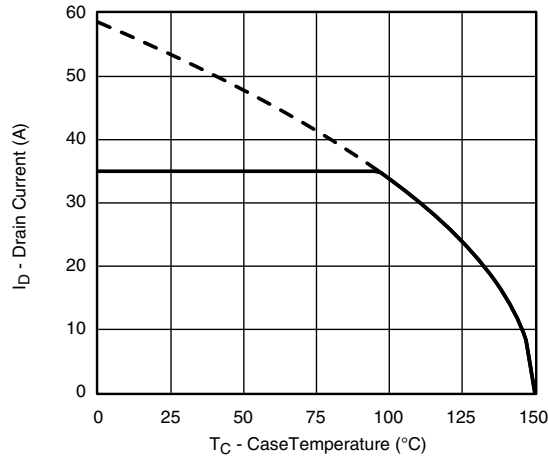
Single Pulse Power, Junction-to-Ambient



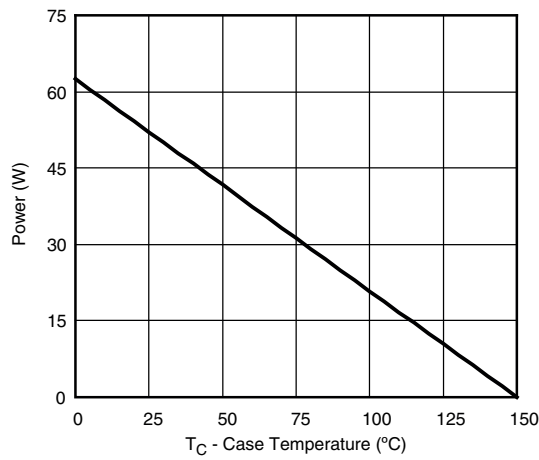
Safe Operating Area, Junction-to-Ambient



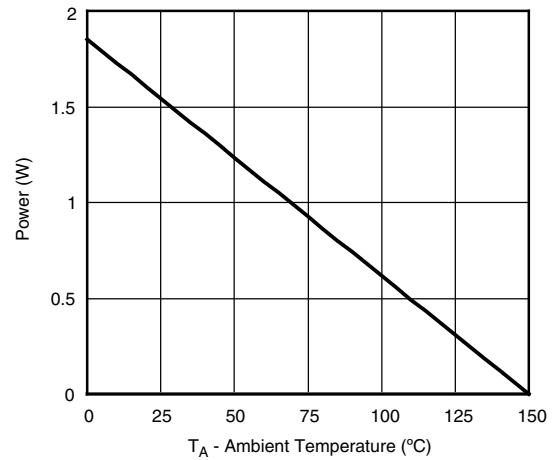
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Current Derating ^a



Power, Junction-to-Case



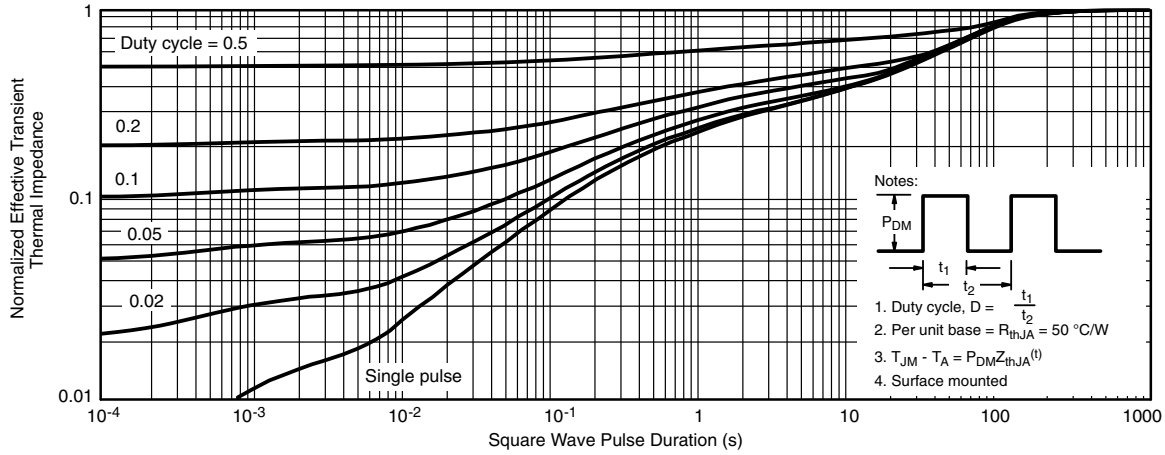
Power, Junction-to-Ambient

Note

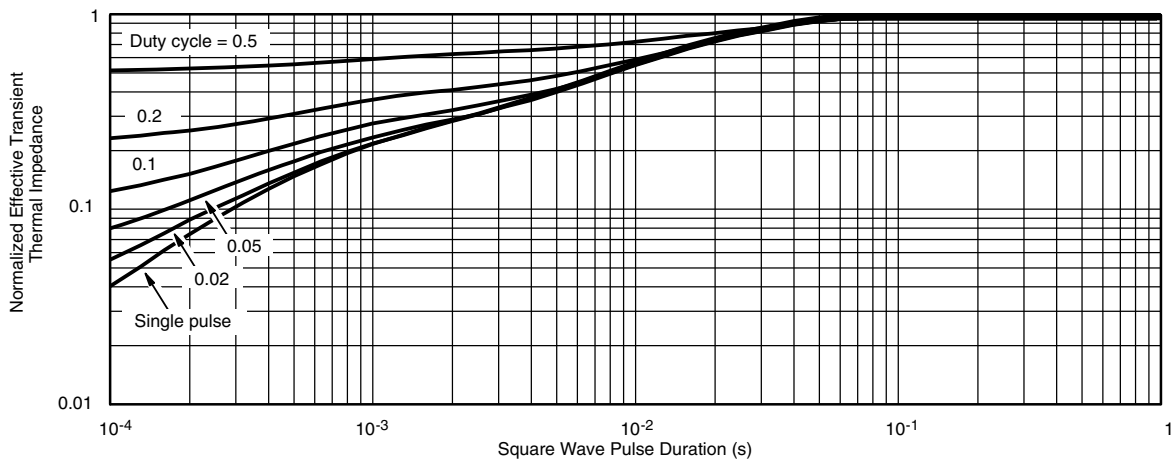
- a. The power dissipation P_D is based on T_J max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient

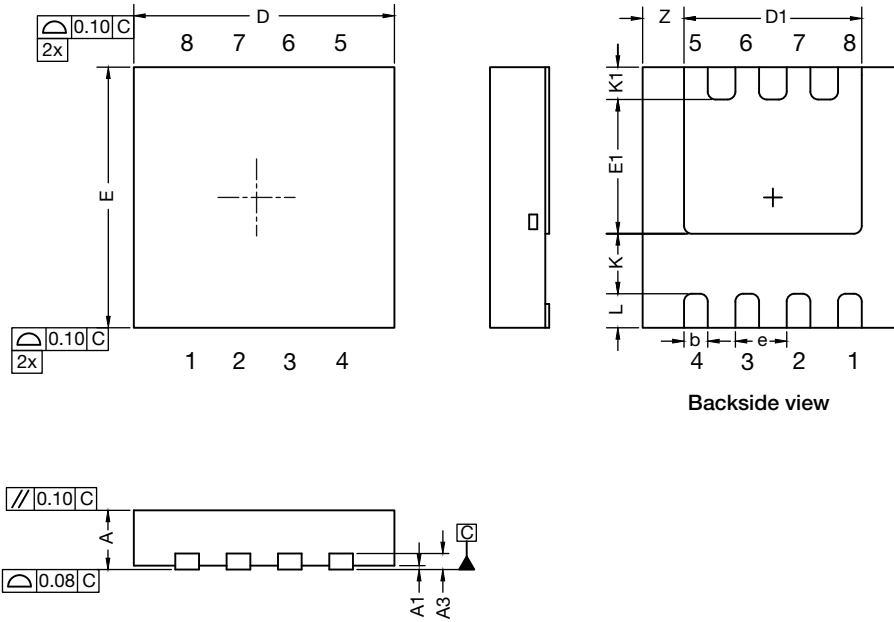


Normalized Thermal Transient Impedance, Junction-to-Case

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PowerPAK® 1212-SWLH



DIM.	MILLIMETERS			INCHES		
	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.
A	0.82	0.90	0.98	0.032	0.035	0.038
A1	0	-	0.05	0	-	0.002
A3	0.20 ref.			0.008 ref.		
b	0.30 BSC			0.012 BSC		
D	3.30 BSC			0.130 BSC		
D1	2.15	2.25	2.35	0.084	0.088	0.092
E	3.30 BSC			0.130 BSC		
E1	1.60	1.70	1.80	0.063	0.067	0.071
e	0.65 BSC			0.026 BSC		
K	0.76 typ.			0.030 typ.		
K1	0.41 typ.			0.016 typ.		
L	0.43 BSC			0.017 BSC		
Z	0.525 typ.			0.021 typ.		

ECN: C18-0001-Rev. A, 15-Jan-18
 DWG: 6062



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